

#### Description

The µPD41464 is a 65,536-word by 4-bit dynamic RAM designed to operate from a single +5-volt power supply and fabricated with a double polylayer, N-channel silicon-gate process for high density, high performance, and high reliability. A single-transistor storage cell and advanced dynamic circuitry ensure minimum power dissipation, while an on-chip feature internally generates the negative voltage substrate bias—automatically and transparently.

The three-state I/O is controlled by  $\overline{\text{CAS}}$  independent of  $\overline{\text{RAS}}$ . After a valid read or hidden refresh cycle, data is held by holding  $\overline{\text{CAS}}$  low. Data input and output is returned to high impedance by returning  $\overline{\text{CAS}}$  high. Hidden refreshing allows  $\overline{\text{CAS}}$  to be held low to maintain output data while  $\overline{\text{RAS}}$  is used to execute  $\overline{\text{RAS}}$ -only refresh cycles.

Refreshing may be accomplished by means of a  $\overline{\text{CAS}}$  before  $\overline{\text{RAS}}$  cycle that internally generates the refresh address, by means of  $\overline{\text{RAS}}$ -only refresh cycles, or by normal read or write cycles on the 256 address combinations of  $A_0$  through  $A_7$  during a 4-ms refresh period.

#### **Features**

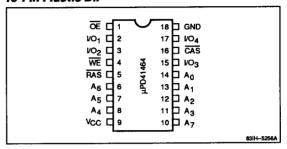
- 65,536-word by 4-bit organization
- ☐ Single + 5-volt ±10% power supply
- CAS before RAS internal refreshing
- Multiplexed address inputs
- On-chip substrate bias generator
- Low power dissipation
  - -28 mA max (standby)
  - -440 mW (active,  $t_{RC} = t_{RC}$  min)
- Nonlatched, TTL-compatible inputs and outputs
- Low input capacitance
- 256 refresh cycles every 4 ms
- □ Standard 18-pin plastic DIP and PLCC packaging

#### Ordering Information

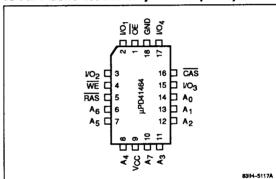
| Part Number  | Row Access Time (max) | Package            |
|--------------|-----------------------|--------------------|
| μPD41464C-80 | 80 ns                 | 18-pin plastic DIP |
| C-10         | 100 ns                | -                  |
| C-12         | 120 ns                |                    |
| μPD41464L-80 | 80 ns                 | 18-pin PLCC        |
| L-10         | 100 ns                | _                  |
| L-12         | 120 ns                | -                  |

### Pin Configurations

#### 18-Pin Plastic DIP



#### 18-Pin Plastic Leaded Chip Carrier (PLCC)





#### Pin Identification

| Name                            | Function                |  |
|---------------------------------|-------------------------|--|
| A <sub>0</sub> - A <sub>7</sub> | Address inputs          |  |
| 1/01 - 1/04                     | Data inputs and outputs |  |
| CAS                             | Column address strobe   |  |
| ÖĒ                              | Output enable           |  |
| RAS                             | Row address strobe      |  |
| WE                              | Write enable            |  |
| GND                             | Ground                  |  |
| Vcc                             | +5-volt power supply    |  |
| NC                              | No connection           |  |

## Capacitance

TA = 25°C; f = 1 MHz

| Parameter                | Symbol          | Max | Unit | Pins Under Test                           |
|--------------------------|-----------------|-----|------|---|
| Input capacitance        | C <sub>I1</sub> | 5   | pF   | A <sub>0</sub> through A <sub>7</sub>     |
|                          | C <sub>I2</sub> | 8   | pF   | RAS, CAS, WE, OE                          |
| Input/output capacitance | Co              | 7   | рF   | I/O <sub>4</sub> through I/O <sub>4</sub> |

## **Absolute Maximum Ratings**

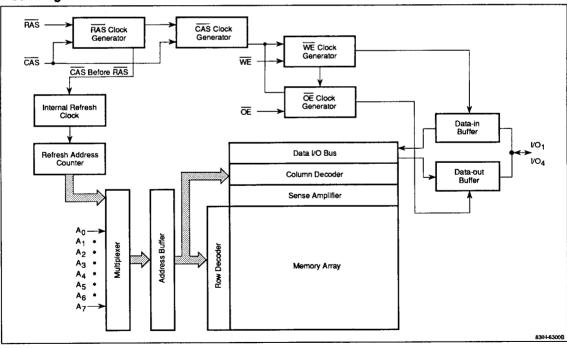
| Voltage on any pin relative to GND            | -1.0 to +7.0 V |
|---|----------------|
| Operating temperature, T <sub>OPR</sub>       | 0 to +70°C     |
| Storage temperature, T <sub>STG</sub>         | -55 to +125°C  |
| Short-circuit output current, I <sub>OS</sub> | 50 mA          |
| Power dissipation, P <sub>D</sub>             | 1.0 W          |

Exposure to Absolute Maximum Ratings for extended periods may affect device reliability; exceeding the ratings could cause permanent damage. The device should be operated within the limits specified under DC and AC Characteristics.

## **Recommended Operating Conditions**

| Parameter           | Symbol          | Min | Тур | Max                 | Unit |  |
|---------------------|-----------------|-----|-----|---------------------|------|--|
| Input voltage, high | V <sub>IH</sub> | 2.4 |     | V <sub>CC</sub> + 1 | ٧    |  |
| Input voltage, low  | V <sub>IL</sub> | -1  |     | 0.8                 | ٧    |  |
| Supply voltage      | Vcc             | 4.5 | 5.0 | 5.5                 | ٧    |  |
| Ambient temperature | T <sub>A</sub>  | 0   |     | 70                  | °C   |  |

## **Block Diagram**





## **DC Characteristics**

 $T_A = 0 \text{ to } +70^{\circ}\text{C}; V_{CC} = +5.0 \text{ V } \pm 10\%$ 

| Parameter              | Symbol            | Min | Max | Unit | Test Conditions   |
|------------------------|-------------------|-----|-----|------|---|
| Standby current        | loca              |     | 5.0 | mA   | RAS = CAS = V <sub>IH</sub>   |
| Input leakage current  | l <sub>I(L)</sub> | 10  | 10  | μΑ   | $V_{IN} = 0 \text{ V to } V_{CC}$ ; all other pins not under test = 0 V |
| Output leakage current | l <sub>O(L)</sub> | -10 | 10  | μΑ   | I/O is high-Z; V <sub>VO</sub> = 0 V to V <sub>CC</sub>                 |
| Output voltage, low    | V <sub>OL</sub>   | 0   | 0.4 | ٧    | I <sub>OL</sub> = 4.2 mA  |
| Output voltage, high   | V <sub>OH</sub>   | 2.4 | Vcc | ٧    | $l_{OH} = -5 \text{ mA}$  |

## **AC Characteristics**

 $T_A = 0 \text{ to } +70^{\circ}\text{C}; V_{CC} = +5.0 \text{ V } \pm 10\%$ 

|  | μPD41464-80 μPD41464-10 μPD41464-12 |     |       |     |       |     |       |      |   |
|--|-------------------------------------|-----|-------|-----|-------|-----|-------|------|---|
| Parameter  | Symbol                              | Min | Max   | Min | Max   | Min | Max   | Unit | Test Conditions   |
| Operating current, average                               | lcc1                                |     | 85    |     | 80    |     | 75    | mA   | RAS, CAS cycling;<br>t <sub>RC</sub> = t <sub>RC</sub> min (Note 5)                       |
| Operating current, refresh cycle, average                | I <sub>CC3</sub>                    |     | 70    |     | 65    |     | 60    | mA   | RAS cycling; CAS = V <sub>IH</sub> ;<br>t <sub>RC</sub> = t <sub>RC</sub> min (Note 5)    |
| Operating current, page cycle, average                   | lcc4                                |     | 60    |     | 55    |     | 50    | mA   | RAS = V <sub>IL</sub> ; CAS cycling;<br>t <sub>PC</sub> = t <sub>PC</sub> min (Note 5)    |
| Operating current, CAS before RAS refresh cycle, average | I <sub>CC5</sub>                    |     | 70    |     | 70    |     | 65    | mA   | $\overline{RAS}$ cycling; $\overline{CAS} \ge V_{IH}$ ;<br>$t_{RC} = t_{RC}$ min (Note 5) |
| Random read or write cycle time                          | t <sub>RC</sub>                     | 160 |       | 200 |       | 220 |       | ns   | (Note 6)  |
| Read-write cycle time                                    | t <sub>RWC</sub>                    | 230 |       | 270 |       | 300 |       | ns   | (Note 6)  |
| Page cycle time  | tPC                                 | 70  |       | 100 |       | 120 |       | ns   | (Note 6)  |
| Refresh period   | tREF                                |     | 4     |     | 4     |     | 4     | ms   |   |
| Access time from RAS                                     | tRAC                                |     | 80    |     | 100   |     | 120   | ns   | (Notes 7, 8)  |
| Access time from CAS                                     | tCAC                                |     | 40    |     | 50    |     | 60    | ns   | (Notes 7, 9)  |
| Ouput buffer turnoff delay                               | toff                                | 0   | 20    | 0   | 25    | 0   | 30    | ns   | (Note 10)   |
| Rise and fall transition time                            | tŢ                                  | 3   | 50    | 3   | 50    | 3   | 50    | ns   | (Notes 2, 3)  |
| RAS precharge time                                       | t <sub>RP</sub>                     | 70  |       | 90  |       | 90  |       | ns   |   |
| RAS pulse width  | tRAS                                | 80  | 10000 | 100 | 10000 | 120 | 10000 | ns   |   |
| RAS hold time  | t <sub>RSH</sub>                    | 40  |       | 50  |       | 60  |       | ns   |   |
| CAS pulse width  | t <sub>CAS</sub>                    | 40  | 10000 | 50  | 10000 | 60  | 10000 | ns   |   |
| CAS hold time  | t <sub>CSH</sub>                    | 80  |       | 100 |       | 120 |       | ns   |   |
| RAS to CAS delay time                                    | tRCD                                | 20  | 40    | 20  | 50    | 25  | 60    | ns   | (Note 11)   |
| CAS to RAS precharge time                                | t <sub>CRP</sub>                    | 10  |       | 10  |       | 10  |       | ns   | (Note 12)   |
| CAS precharge time for nonpage cycle                     | <sup>‡</sup> CPN                    | 25  |       | 25  |       | 25  |       | ns   |   |
| CAS precharge time for page cycle                        | top                                 | 30  |       | 40  |       | 50  |       | ns   |   |
| RAS precharge CAS hold time                              | t <sub>RPC</sub>                    | 0   |       | 0   |       | 0   |       | ns   |   |
| Row address setup time                                   | t <sub>ASR</sub>                    | 0   |       | 0   |       | 0   |       | ns   |   |
| Row address hold time                                    | tRAH                                | 10  |       | 10  |       | 15  |       | ns   |   |
| Column address setup time                                | tasc                                | 0   |       | 0   |       | 0   |       | ns   |   |
| Column address hold time                                 | t <sub>CAH</sub>                    | 15  |       | 15  |       | 20  |       | ns   |   |
| Column address hold time referenced to RAS               | t <sub>AR</sub>                     | 55  |       | 65  |       | 80  |       | ns   |   |



# **AC Characteristics (cont)**

|   |                  | μPD41 | 1464 <del>-8</del> 0 | μPD41 | 464-10 | μPD41 | 464-12 |      | Test Conditions |
|---|------------------|-------|----------------------|-------|--------|-------|--------|------|-----------------|
| Parameter .                                     | Symbol           | Min   | Max                  | Min   | Max    | Min   | Max    | Unit |                 |
| Read command hold time referenced to RAS        | tarn             | 10    |                      | 10    |        | 10    |        | ns   | (Note 13)       |
| Read command hold time referenced to CAS        | <b>t</b> ясн     | 0     |                      | 0     |        | 0     |        | ns   | (Note 13)       |
| Write command hold time                         | \$wcH            | 20    |                      | 25    |        | 30    |        | ns   |                 |
| Write command hold time referenced to RAS       | ¹wcn             | 60    |                      | 75    |        | 90    |        | ns   |                 |
| Write command pulse width                       | ₩P               | 20    |                      | 15    |        | 20    |        | ns   |                 |
| Write command to RAS lead time                  | \$RWL            | 30    |                      | 35    |        | 40    |        | ns   |                 |
| Write command to CAS lead time                  | <sup>‡</sup> CWL | 30    |                      | 35    |        | 40    |        | ns   |                 |
| Data-in setup time                              | tos              | 0     |                      | 0     |        | 0     |        | ns   | (Note 14)       |
| Data-in hold time                               | ₽ОН              | 20    |                      | 25    |        | 30    |        | ns   | (Note 14)       |
| Data-in hold time referenced to RAS             | <sup>‡</sup> DHR | 60    |                      | 75    |        | 90    |        | ns   |                 |
| Write command setup time                        | ₩cs              | 0     |                      | 0     |        | 0     |        | ns   | (Note 15)       |
| RAS to WE delay                                 | <sup>t</sup> RWD | 105   |                      | 130   |        | 155   |        | ns   | (Note 15)       |
| CAS to WE delay                                 | †cwD             | 65    |                      | 80    |        | 95    |        | ns   | (Note 15)       |
| Access time from OE                             | <sup>t</sup> OEA |       | 20                   |       | 25     |       | 30     | ns   |                 |
| Data delay time                                 | t <sub>OED</sub> | 20    |                      | 25    |        | 30    |        | ns   |                 |
| OE command hold time                            | <sup>t</sup> OEH | 0     |                      | 0     |        | 0     |        | ns   |                 |
| Output turnoff delay from OE                    | †OEZ             | 0     | 20                   | 0     | 25     | 0     | 30     | ns   |                 |
| OE to RAS inactive setup time                   | t <sub>OES</sub> | 10    |                      | 10    |        | 10    |        | ns   |                 |
| Read or write cycle time for counter test cycle | t <sub>TRC</sub> | 185   |                      | 220   |        | 245   |        | ns   | (Note 16)       |
| Read or write cycle time for counter test cycle | †TRWC            | 245   |                      | 290   |        | 325   |        | ns   | (Note 16)       |
| CAS setup time for CAS-before RAS refresh cycle | <sup>1</sup> CSR | 10    |                      | 10    |        | 10    |        | ns   |                 |
| CAS hold time for CAS before RAS refresh cycle  | <sup>‡</sup> CHR | 15    |                      | 20    |        | 25    |        | ns   |                 |



#### Notes:

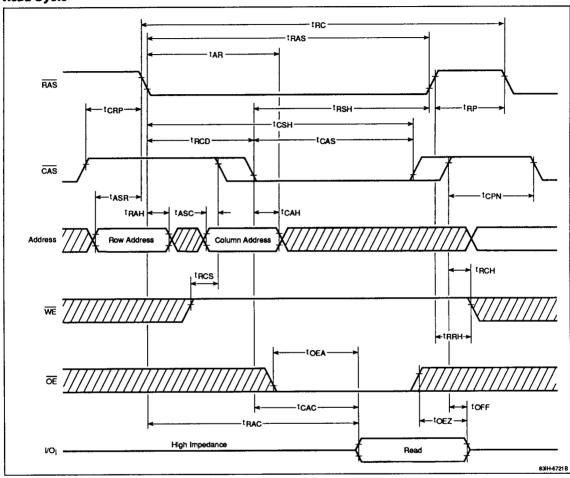
- An initial pause of 100 μs (RAS inactive) is required after power-up, followed by any eight RAS cycles, before proper device operation is achieved.
- (2) AC measurements assume t<sub>T</sub> = 5 ns.
- (3) V<sub>IH</sub> (min) and V<sub>IL</sub> (max) are reference levels for measuring the timing of input signals.
- (4) All voltages are referenced to GND.
- (5) I<sub>CC1</sub>, I<sub>CC3</sub>, I<sub>CC4</sub>, and I<sub>CC5</sub> depend on output loading and cycle rates. Specified values are obtained with the output open. For lot code K of the μPD41464-15, t<sub>RC</sub> (min) must be 270 ns and I<sub>CC3</sub> = 60 mA.
- (6) The minimum specifications are used only to indicate the cycle time at which proper operation over the full temperature range (T<sub>A</sub> = 0 to +70°C) is assured. For lot code K of the μPD41464-15, t<sub>BC</sub> (min) must be 270 ns.
- (7) Load = 2 TTL loads and 100 pF
- (8) Assumes that t<sub>RCD</sub> ≤ t<sub>RCD</sub> (max). If t<sub>RCD</sub> is greater than the maximum recommended value in this table, t<sub>RAC</sub> increases by the amount that t<sub>RCD</sub> exceeds the value shown. For a CAS before RAS refresh counter test cycle, t<sub>RAC</sub> is specified as t<sub>RAC</sub> = t<sub>CHR</sub> + t<sub>CP</sub> + t<sub>CAC</sub> + 2t<sub>T</sub> and is greater than the maximum specified value shown in this table.
- (9) Assumes that t<sub>RCD</sub> ≥ t<sub>RCD</sub> (max).

- (10) t<sub>OFF</sub> (max) and t<sub>OEZ</sub> (max) define the time at which the output achieves the open-circuit condition and are not referenced to V<sub>OH</sub> or V<sub>OL</sub>.
- (11) Operation within the t<sub>RCD</sub> (max) limit assures that t<sub>RAC</sub> (max) can be met. t<sub>RCD</sub> (max) is specified as a reference point only; if t<sub>RCD</sub> is greater than t<sub>RCD</sub> (max), access time is controlled exclusively by t<sub>CAC</sub>.
- (12) The t<sub>CRP</sub> requirement should be applicable for RAS/CAS cycles preceded by any cycle.
- (13) Either t<sub>RRH</sub> or t<sub>RCH</sub> must be satisfied for a read cycle.
- (14) These parameters are referenced to the leading edge of CAS for early write cycles and to the leading edge of WE for delayed write or read-modify-write cycles.
- (15) t<sub>WCS</sub>, t<sub>CWD</sub>, and t<sub>RWD</sub> are restrictive operating parameters in read-write/read-modify-write cycles only. If t<sub>WCS</sub> ≥ t<sub>WCS</sub> (min), the cycle is an early write cycle and the data I/O pins will remain high impedance throughout the entire cycle. If t<sub>CWD</sub> ≥ t<sub>CWD</sub> (min), t<sub>RWD</sub> ≥ t<sub>RWD</sub> (min), the cycle is a read-write cycle and the data I/O pins will contain data read from the selected cell. If neither of the above conditions is met, the condition of the data I/O pins (at access time and until CAS returns to V<sub>IH</sub>) is indeterminate.
- (16) t<sub>TRC</sub> and t<sub>TRWC</sub> are applicable for CAS before RAS refresh counter test cycles.



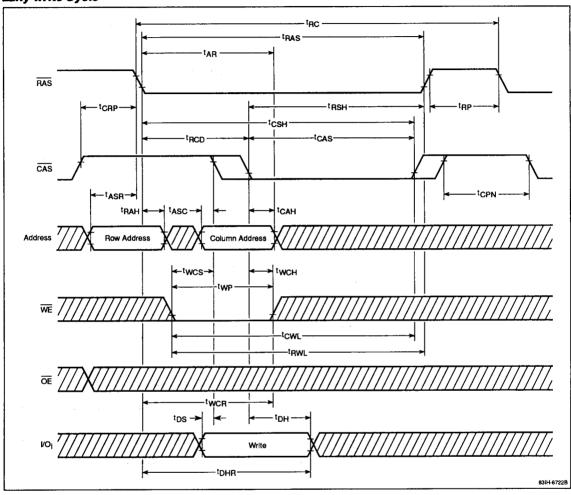
# **Timing Waveforms**

# Read Cycle



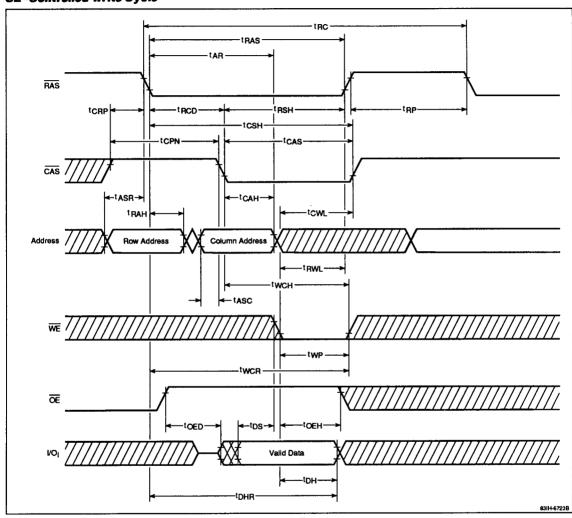


# Early Write Cycle



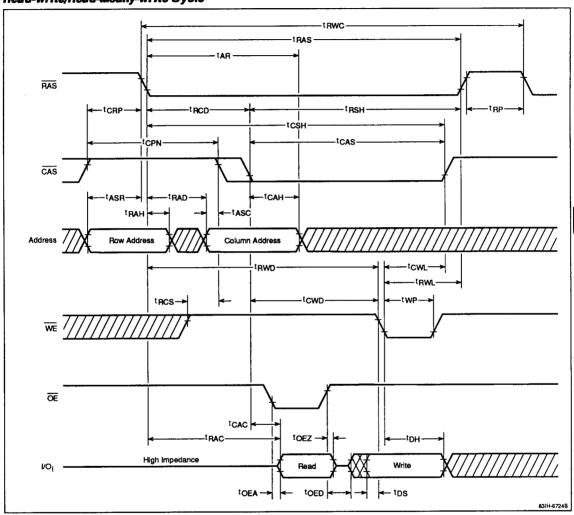


# **OE** -Controlled Write Cycle



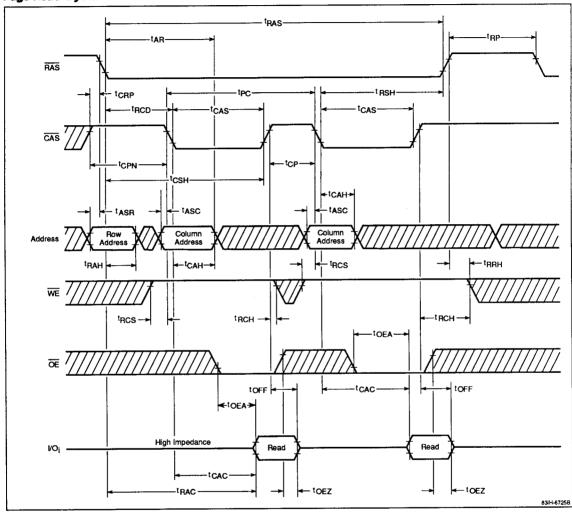


## Read-Write/Read-Modify-Write Cycle



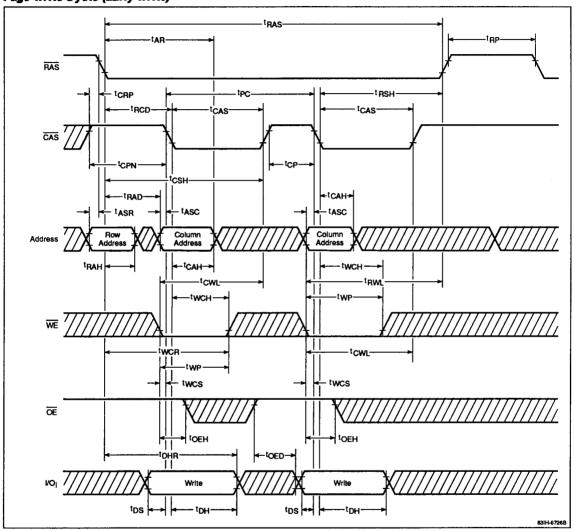


## Page Read Cycle



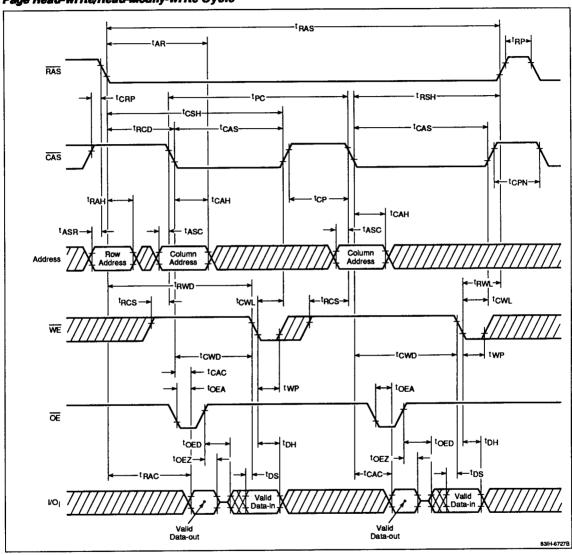


# Page Write Cycle (Early Write)



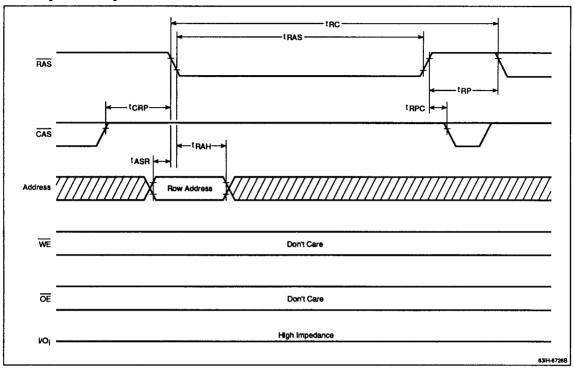


# Page Read-Write/Read-Modify-Write Cycle



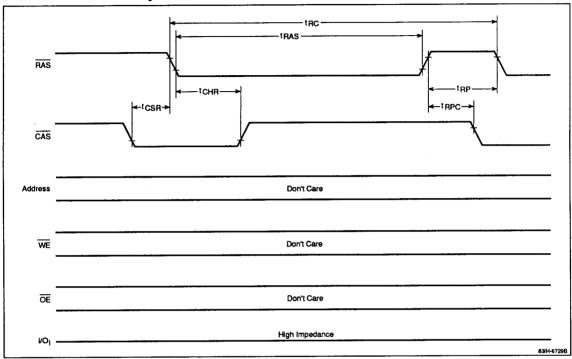


# RAS-Only Refresh Cycle



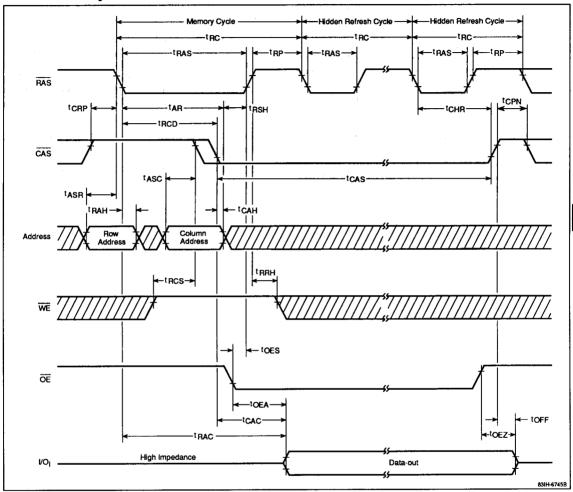


# CAS Before RAS Refresh Cycle





## Hidden Refresh Cycle





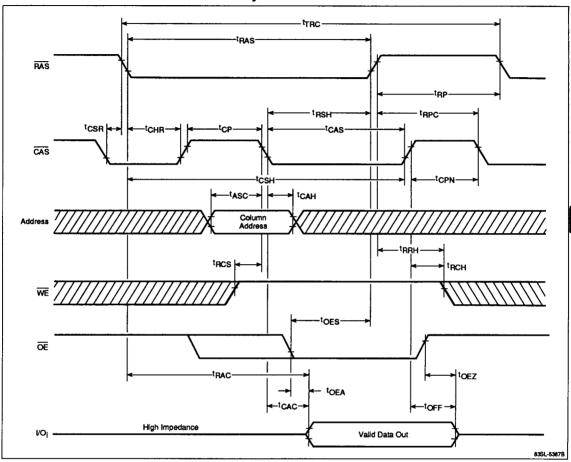
#### CAS Before RAS Refresh Counter Test

The uPD41464 provides a method to verify proper operation of the internal address counter used in CAS before RAS refreshing. After a CAS before RAS refresh cycle is initiated, CAS satisfies a hold time (t<sub>CHR</sub>), a precharge time (t<sub>CP</sub>), and then returns low while RAS is held low to enable read, write, or read-modify-write operation. As shown in the appropriate timing waveforms, a refresh counter test can be initiated at this point on specified row and column addresses. The row is selected by the internal address counter, and the column is defined by an external address supplied at the second falling edge of CAS. Test patterns can be generated in several ways; the following example is one possibility. Any pattern must be preceded by the normal power-up procedure containing a pause of 100  $\mu s$  and then eight  $\overline{RAS}$  cycles to initialize the internal counter.

- (1) Write "0" into 256 memory cells with 256 CAS before RAS refresh counter test write cycles. Use the same column address in each cycle.
- (2) Use a counter test read-modify-write cycle to read the "0" written in the first cycle of step 1 and then write a "1" into that location in the same cycle. Perform this operation 256 times, until a "1" is written into each of the 256 memory cells. Continue using the same column address as specified in step 1.
- (3) Read each "1" written in step 2 using a counter test read cycle.
- (4) Complement the test pattern and repeat steps 1, 2, and 3.

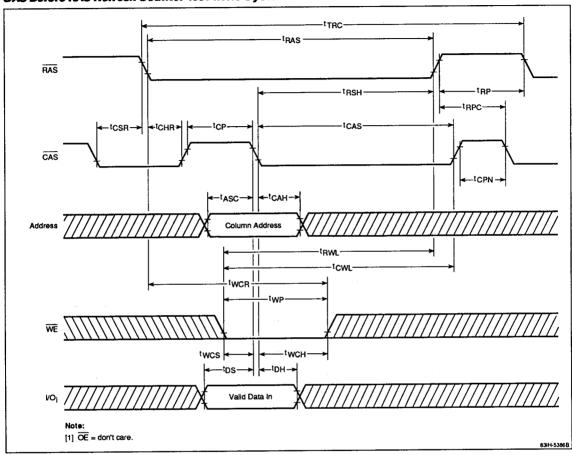


# CAS Before RAS Refresh Counter Test Read Cycle



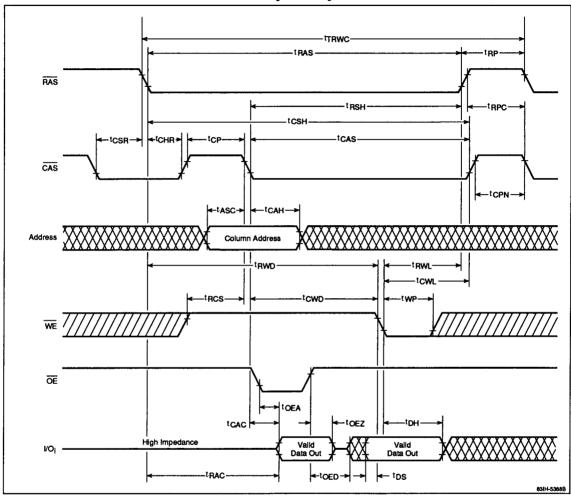


# CAS Before RAS Refresh Counter Test Write Cycle





## CAS Before RAS Refresh Counter Test Read-Modify-Write Cycle



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